KSZ8041NL



10Base-T/100Base-TX Physical Layer Transceiver

Data Sheet Rev. 1.2

General Description

The KSZ8041NL is a single supply 10Base-T/100Base-TX Physical Layer Transceiver, which provides MII/RMII interfaces to transmit and receive data. An unique mixed signal design extends signaling distance while reducing power consumption.

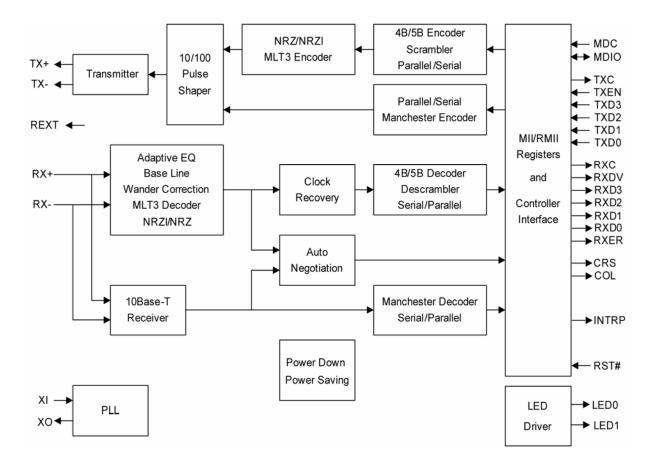
HP Auto MDI/MDI-X provides the most robust solution for eliminating the need to differentiate between crossover and straight-through cables.

The KSZ8041NL represents a new level of features and performance and is an ideal choice of physical layer transceiver for 10Base-T/100Base-TX applications.

The KSZ8041NL comes in a 32-pin, lead-free MLF[®] (QFN per JDEC) package (See Ordering Information).

Data sheets and support documentation can be found on Micrel's web site at: www.micrel.com.

Functional Diagram



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Features

- Single-chip 10Base-T/100Base-TX physical layer solution
- Fully compliant to IEEE 802.3u Standard
- Low power CMOS design, power consumption of <180mW
- HP auto MDI/MDI-X for reliable detection and correction for straight-through and crossover cables with disable and enable option
- Robust operation over standard cables
- Power down and power saving modes
- MII interface support
- RMII interface support with external 50MHz system clock
- MIIM (MDC/MDIO) management bus to 6.25MHz for rapid PHY register configuration
- Interrupt pin option
- Programmable LED outputs for link, activity and speed
- ESD rating (6kV)
- Single power supply (3.3V)
- Built-in 1.8V regulator for core
- Available in 32-pin (5mm x 5mm) MLF[®] package

Applications

- Printer
- LOM
- Game Console
- IPTV
- IP Phone
- IP Set-top Box

Ordering Information

Part Number	Temp. Range	Package	Lead Finish	Description
KSZ8041NL	0°C to 70°C	32-Pin MLF [®]	Pb-Free	Commercial Temperature Device
KSZ8041NLI (1)	-40°C to 85°C	32-Pin MLF [®]	Pb-Free	Industrial Temperature Device
KSZ8041NL AM ⁽¹⁾	-40°C to 85°C	32-Pin MLF [®]	Pb-Free	Automotive Qualified Device

Note:

1. Contact factory for lead time.

Revision History

Revision	Date	Summary of Changes				
1.0	10/13/06	Data sheet created.				
1.1	4/27/07	Added maximum MDC clock speed.				
		Added 40K +/-30% to note 1 of Pin Description and Strapping Options tables for internal pull-ups/pull-downs.				
		Changed Model Number in Register 3h – PHY Identifier 2.				
		Changed polarity (swapped definition) of DUPLEX strapping pin.				
		Removed DUPLEX strapping pin update to Register 4h – Auto-Negotiation Advertisement bits [8, 6].				
		Set "Disable power saving" as the default for Register 1Fh bit [10].				
		Corrected LED1 (pin 31) definition for Activity in LED mode 01.				
		Added Symbol Error to MII/RMII Receive Error description and Register 15h – RXER Counter.				
		Added a 100pF capacitor on REXT (pin 10) in Pin Description table.				
1.2	7/18/08	Added Automotive Qualified part number to Ordering Information.				
		Added maximum case temperature.				
		Added thermal resistance (θ_{JC}).				
		Added chip maximum current consumption.				

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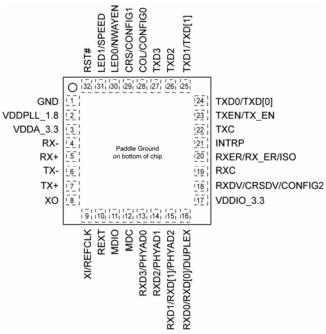
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Pin Configuration



32-Pin (5mm x 5mm) MLF®

Pin Description

Pin Number	Pin Name	Type ⁽¹⁾	Pin Function			
1	GND	Gnd	Ground			
2	VDDPLL_1.8	Р	1.8V analog V _{DD}	1.8V analog V _{DD}		
3	VDDA_3.3	Р	3.3V analog V _{DD}			
4	RX-	I/O	Physical receive	or transmit signal (- differential)		
5	RX+	I/O	Physical receive	or transmit signal (+ differential)		
6	TX-	I/O	Physical transmi	t or receive signal (- differential)		
7	TX+	I/O	Physical transmi	t or receive signal (+ differential)		
8	XO	0	Crystal feedback	4		
			This pin is used	only in MII mode when a 25 MHz crystal is used.		
			This pin is a no o	connect if oscillator or external clock source is used, or if RMII d.		
9	XI /	I	Crystal / Oscillat	or / External Clock Input		
	REFCLK		MII Mode:	25MHz +/-50ppm (crystal, oscillator, or external clock)		
			RMII Mode:	50MHz +/-50ppm (oscillator, or external clock only)		
10	REXT	I/O	Set physical tran	smit output current		
				Ω resistor in parallel with a 100pF capacitor to ground on this 41NL reference schematics.		
11	MDIO	I/O	Management Int	erface (MII) Data I/O		
			This pin requires	an external 4.7K Ω pull-up resistor.		
12	MDC	1	Management Interface (MII) Clock Input			
			This pin is synch	ronous to the MDIO data interface.		
13	RXD3 /	lpu/O	MII Mode:	Receive Data Output[3] ⁽²⁾ /		
	PHYAD0		Config Mode:	The pull-up/pull-down value is latched as PHYADDR[0] during power-up / reset. See "Strapping Options" section for details.		
14	RXD2 /	lpd/O	MII Mode:	Receive Data Output[2] ⁽²⁾ /		
	PHYAD1		Config Mode:	The pull-up/pull-down value is latched as PHYADDR[1] during power-up / reset. See "Strapping Options" section for details.		
15	RXD1 /	lpd/O	MII Mode:	Receive Data Output[1] ⁽²⁾ /		
	RXD[1] /		RMII Mode:	Receive Data Output[1] ⁽³⁾ /		
	PHYAD2		Config Mode:	The pull-up/pull-down value is latched as PHYADDR[2] during power-up / reset. See "Strapping Options" section for details.		
16	RXD0 /	lpu/O	MII Mode:	Receive Data Output[0] ⁽²⁾ /		
	RXD[0] /		RMII Mode:	Receive Data Output[0] ⁽³⁾ /		
	DUPLEX		Config Mode: Latched as DUPLEX (register 0h, bit 8) during power-up / reset. See "Strapping Options" section for details.			
17	VDDIO_3.3	Р	3.3V digital V _{DD}	-		
18	RXDV /	lpd/O	MII Mode:	Receive Data Valid Output /		
	CRSDV /		RMII Mode:	Carrier Sense/Receive Data Valid Output /		
	CONFIG2		Config Mode: The pull-up/pull-down value is latched as CONFIG2 during power-up / reset. See "Strapping Options" section for details.			
	RXC	0	MII Mode:	Receive Clock Output		

Pin Number	Pin Name	Type ⁽¹⁾	Pin Function						
20	RXER /	Ipd/O	MII Mode:	Receive Error Output /					
	RX_ER /		RMII Mode:	Receive Error Outpu	t /				
	ISO		Config Mode:	The pull-up/pull-down value is latched as ISOLATE during power-up / reset. See "Strapping Options" section for details.					
21	INTRP	Opu	Interrupt Output:	Interrupt Output: Programmable Interrupt Output					
			conditions and re	Register 1Bh is the Interrupt Control/Status Register for programming the interrupt conditions and reading the interrupt status. Register 1Fh bit 9 sets the interrupt output to active low (default) or active high.					
22	TXC	0	MII Mode:	Transmit Clock Outp	ut				
23	TXEN /	I	MII Mode:	Transmit Enable Inpo	ut /				
	TX_EN		RMII Mode:	Transmit Enable Inpo	ut				
24	TXD0 /	1	MII Mode:	Transmit Data Input[0] ⁽⁴⁾ /				
	TXD[0]		RMII Mode:	Transmit Data Input[0] ⁽⁵⁾				
25	TXD1 /	I	MII Mode:	Transmit Data Input[1] ⁽⁴⁾ /				
	TXD[1]		RMII Mode:	Transmit Data Input[1] ⁽⁵⁾				
26	TXD2	1	MII Mode:	Transmit Data Input[2] ⁽⁴⁾ /				
27	TXD3	I	MII Mode:	Transmit Data Input[3] ⁽⁴⁾ /				
28	COL/	lpd/O	MII Mode:	Collision Detect Outp					
	CONFIG0		Config Mode:	The pull-up/pull-down value is latched as CONFIG0 during power-up / reset. See "Strapping Options" section for details.					
29	CRS/	Ipd/O	MII Mode:						
	CONFIG1		Config Mode:	onfig Mode: The pull-up/pull-down value is latched as CONFIG1 during power-up / reset. See "Strapping Options" section for details.					
30	LED0 /	Ipu/O	LED Output:	Programmable LED0	Output /				
	NWAYEN			ode: Latched as Auto-Negotiation Enable (register 0h, bit 12) during power-up / reset. See "Strapping Options" section for details. 0 pin is programmable via register 1Eh bits [15:14], and is defined as					
			follows.			_			
			LED mode = [00]					
			Link/Activity	Pin State	LED Definition				
			No Link	Н	OFF				
			Link	L	ON				
			Activity	Toggle	Blinking				
			LED mode = [01]]			
			Link	Pin State	LED Definition				
			No Link	Н	OFF				
			Link	L ON					
			LED mode = [10] Reserved	1					
			<u>LED mode = [11</u>	1					
			Reserved						

Pin Number	Pin Name	Type ⁽¹⁾	Pin Function					
31	LED1 /	lpu/O	LED Output: Programmable LED1 Output /					
	SPEED		Config Mode:		D (register 0h, bit 13) du ptions" section for detail			
			The LED1 pin is follows.	programmable via r	egister 1Eh bits [15:14]	, and is defined as		
			LED mode = [[00]				
			Speed	Pin State	LED Definition			
			10BT	Н	OFF			
			100BT	L	ON			
				•	•	•		
			LED mode = [01]				
			Activity	Pin State	LED Definition			
			No Activity	Н	OFF			
			Activity	Toggle	Blinking			
			LED mode = [10] Reserved	<u>01</u>				
			<u>LED mode = [11</u>	<u>u</u>				
			Reserved					
32	RST#	1	Chip Reset (activ	ve low)				
PADDLE	GND	Gnd	Ground					

Notes:

1. P = Power supply.

Gnd = Ground.

I = Input.

O = Output.

I/O = Bi-directional.

Ipd = Input with internal pull-down (40K +/-30%).

Ipu = Input with internal pull-up (40K +/-30%).

Opu = Output with internal pull-up (40K +/-30%).

Ipu/O = Input with internal pull-up (40K +/-30%) during power-up/reset; output pin otherwise.

Ipd/O = Input with internal pull-down (40K +/-30%) during power-up/reset; output pin otherwise.

- 2. MII Rx Mode: The RXD[3..0] bits are synchronous with RXCLK. When RXDV is asserted, RXD[3..0] presents valid data to MAC through the MII. RXD[3..0] is invalid when RXDV is de-asserted.
- 3. RMII Rx Mode: The RXD[1:0] bits are synchronous with REF_CLK. For each clock period in which CRS_DV is asserted, two bits of recovered data are sent from the PHY.
- 4. MII Tx Mode: The TXD[3..0] bits are synchronous with TXCLK. When TXEN is asserted, TXD[3..0] presents valid data from the MAC through the MII. TXD[3..0] has no effect when TXEN is de-asserted.
- 5. RMII Tx Mode: The TXD[1:0] bits are synchronous with REF_CLK. For each clock period in which TX_EN is asserted, two bits of data are received by the PHY from the MAC.

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Strapping Options

Pin Number	Pin Name	Type ⁽¹⁾	Pin Function		Pin Function				
15	PHYAD2	lpd/O		The PHY Address is latched at power-up / reset and is configurable to any value from					
14	PHYAD1	Ipd/O		1 to 7.					
13	PHYAD0	Ipu/O		Address is 00001.					
40	CONFICE	1 1/0		s [4:3] are always set to '00'.					
18	CONFIG2	lpd/O	follows:	strap-in pins are latched at power-up /	reset and are defined as				
29	CONFIG1	lpd/O	10110440.						
28	CONFIG0	lpd/O	CONFIG[2:0]	Mode	7				
			000	MII (default)					
			001	RMII					
			010	Reserved – not used					
			011	Reserved – not used					
			100	PCS Loopback					
			101	Reserved – not used					
			110	Reserved – not used					
			111	Reserved – not used					
20	ISO	Ipd/O	ISOLATE mode						
			Pull-up =	= Enable					
			Pull-dow	n (default) = Disable					
			During power-up / reset, this pin value is latched into register 0h bit 10.						
31	SPEED	Ipu/O	SPEED mode						
			Pull-up (default) = 100Mbps					
			Pull-dow	n = 10Mbps					
			During power-up / reset, this pin value is latched into register 0h bit 13 as the Speed Select, and also is latched into register 4h (Auto-Negotiation Advertisement) as the Speed capability support.						
16	DUPLEX	Ipu/O	DUPLEX mode						
			Pull-up (default) = Half Duplex						
			Pull-down = Full Duplex						
			During power-up / reset, this pin value is latched into register 0h bit 8 as the Duplex Mode.						
30	NWAYEN	lpu/O	Nway Auto-Negot	tiation Enable					
			Pull-up (default) = Enable Auto-Negotiation					
			Pull-down = Disable Auto-Negotiation						
			During power-up	During power-up / reset, this pin value is latched into register 0h bit 12.					

Note:

Pin strap-ins are latched during power-up or reset. In some systems, the MAC receive input pins may drive high during power-up or reset, and consequently cause the PHY strap-in pins on the MII/RMII signals to be latched high. In this case, it is recommended to add 1K pull-downs on these PHY strap-in pins to ensure the PHY does not strap-in to ISOLATE or PCS Loopback mode, or is not configured with an incorrect PHY Address.

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Ipu/O = Input with internal pull-up (40K +/-30%) during power-up/reset; output pin otherwise.
 Ipd/O = Input with internal pull-down (40K +/-30%) during power-up/reset; output pin otherwise.

Functional Description

The KSZ8041NL is a single 3.3V supply Fast Ethernet transceiver. It is fully compliant with the IEEE 802.3u Specification.

On the media side, the KSZ8041NL supports 10Base-T and 100Base-TX with HP auto MDI/MDI-X for reliable detection of and correction for straight-through and crossover cables.

The KSZ8041NL offers a choice of MII or RMII data interface connection with the MAC processor. The MII management bus option gives the MAC processor complete access to the KSZ8041NL control and status registers. Additionally, an interrupt pin eliminates the need for the processor to poll for PHY status change.

Physical signal transmission and reception are enhanced through the use of patented analog circuitries that make the design more efficient and allow for lower power consumption and smaller chip die size.

100Base-TX Transmit

The 100Base-TX transmit function performs parallel-to-serial conversion, 4B/5B coding, scrambling, NRZ-to-NRZI conversion, and MLT3 encoding and transmission.

The circuitry starts with a parallel-to-serial conversion, which converts the MII data from the MAC into a 125MHz serial bit stream. The data and control stream is then converted into 4B/5B coding, followed by a scrambler. The serialized data is further converted from NRZ-to-NRZI format, and then transmitted in MLT3 current output.

The output current is set by an external $6.49k\Omega$ 1% resistor for the 1:1 transformer ratio. It has typical rise/fall times of 4 ns and complies with the ANSI TP-PMD standard regarding amplitude balance, overshoot and timing jitter. The wave-shaped 10Base-T output drivers are also incorporated into the 100Base-TX drivers.

100Base-TX Receive

The 100Base-TX receiver function performs adaptive equalization, DC restoration, MLT3-to-NRZI conversion, data and clock recovery, NRZI-to-NRZ conversion, de-scrambling, 4B/5B decoding, and serial-to-parallel conversion.

The receiving side starts with the equalization filter to compensate for inter-symbol interference (ISI) over the twisted pair cable. Since the amplitude loss and phase distortion is a function of the cable length, the equalizer must adjust its characteristics to optimize performance. In this design, the variable equalizer makes an initial estimation based on comparisons of incoming signal strength against some known cable characteristics, and then tunes itself for optimization. This is an ongoing process and self-adjusts against environmental changes such as temperature variations.

Next, the equalized signal goes through a DC restoration and data conversion block. The DC restoration circuit is used to compensate for the effect of baseline wander and to improve the dynamic range. The differential data conversion circuit converts the MLT3 format back to NRZI. The slicing threshold is also adaptive.

The clock recovery circuit extracts the 125MHz clock from the edges of the NRZI signal. This recovered clock is then used to convert the NRZI signal into the NRZ format. This signal is sent through the de-scrambler followed by the 4B/5B decoder. Finally, the NRZ serial data is converted to the MII format and provided as the input data to the MAC.

PLL Clock Synthesizer

The KSZ8041NL generates 125MHz, 25MHz and 20MHz clocks for system timing. Internal clocks are generated from an external 25MHz crystal or oscillator. In RMII mode, these internal clocks are generated from an external 50MHz oscillator or system clock.

Scrambler/De-scrambler (100Base-TX only)

The purpose of the scrambler is to spread the power spectrum of the signal in order to reduce EMI and baseline wander.

10Base-T Transmit

The 10Base-T drivers are incorporated with the 100Base-TX drivers to allow for transmission using the same magnetic. The drivers also perform internal wave-shaping and pre-emphasize, and output 10Base-T signals with a typical amplitude of 2.5V peak. The 10Base-T signals have harmonic contents that are at least 27dB below the fundamental frequency when driven by an all-ones Manchester-encoded signal.

10Base-T Receive

On the receive side, input buffer and level detecting squelch circuits are employed. A differential input receiver circuit and a PLL performs the decoding function. The Manchester-encoded data stream is separated into clock signal and NRZ data. A squelch circuit rejects signals with levels less than 400 mV or with short pulse widths to prevent noise at the RX+ and RX- inputs from falsely trigger the decoder. When the input exceeds the squelch limit, the PLL locks onto the incoming

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signal and the KSZ8041NL decodes a data frame. The receive clock is kept active during idle periods in between data reception.

SQE and Jabber Function (10Base-T only)

In 10Base-T operation, a short pulse is put out on the COL pin after each frame is transmitted. This SQE Test is required as a test of the 10Base-T transmit/receive path. If transmit enable (TXEN) is high for more than 20 ms (jabbering), the 10Base-T transmitter is disabled and COL is asserted high. If TXEN is then driven low for more than 250 ms, the 10Base-T transmitter is re-enabled and COL is de-asserted (returns to low).

Auto-Negotiation

The KSZ8041NL conforms to the auto-negotiation protocol, defined in Clause 28 of the IEEE 802.3u specification. Auto-negotiation is enabled by either hardware pin strapping (pin 30) or software (register 0h bit 12).

Auto-negotiation allows unshielded twisted pair (UTP) link partners to select the highest common mode of operation. Link partners advertise their capabilities to each other, and then compare their own capabilities with those they received from their link partners. The highest speed and duplex setting that is common to the two link partners is selected as the mode of operation.

The following list shows the speed and duplex operation mode from highest to lowest.

- Priority 1: 100Base-TX, full-duplex
- Priority 2: 100Base-TX, half-duplex
- Priority 3: 10Base-T, full-duplex
- Priority 4: 10Base-T, half-duplex

If auto-negotiation is not supported or the KSZ8041NL link partner is forced to bypass auto-negotiation, the KSZ8041NL sets its operating mode by observing the signal at its receiver. This is known as parallel detection, and allows the KSZ8041NL to establish link by listening for a fixed signal protocol in the absence of auto-negotiation advertisement protocol.

The auto-negotiation link up process is shown in the following flow chart.

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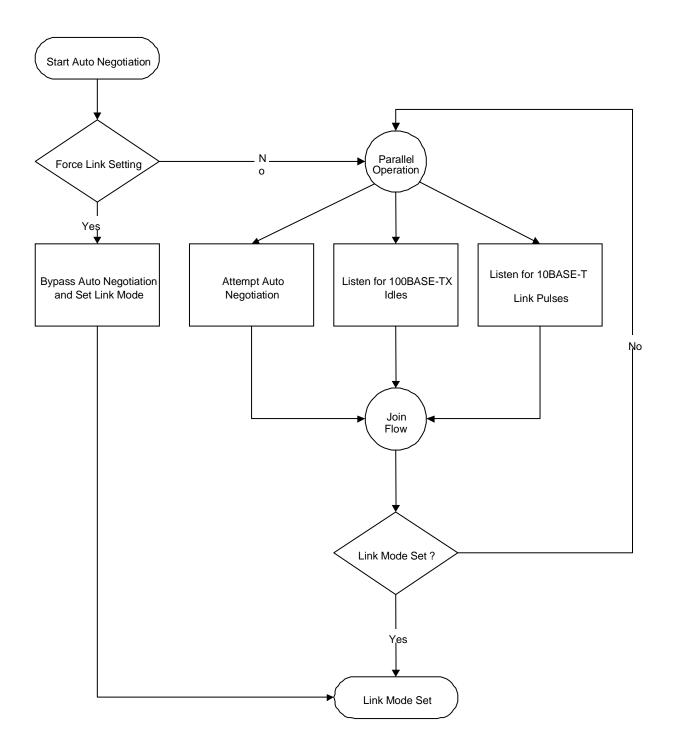


Figure 1. Auto-Negotiation Flow Chart

MII Management (MIIM) Interface

The KSZ8041NL supports the IEEE 802.3 MII Management Interface, also known as the Management Data Input / Output (MDIO) Interface. This interface allows upper-layer devices to monitor and control the state of the KSZ8041NL. An external device with MIIM capability is used to read the PHY status and/or configure the PHY settings. Additional details on the MIIM interface can be found in Clause 22.2.4.5 of the IEEE 802.3u Specification.

The MIIM interface consists of the following:

- A physical connection that incorporates the clock line (MDC) and the data line (MDIO).
- A specific protocol that operates across the aforementioned physical connection that allows an external controller to communicate with one or more KSZ8041NL devices. Each KSZ8041NL device is assigned a PHY address between 1 and 7 by the PHYAD[2:0] strapping pins.
- An internal addressable set of thirteen 16-bit MDIO registers. Register [0:6] are required, and their functions are defined by the IEEE 802.3u Specification. The additional registers are provided for expanded functionality.

The KSZ8041NL supports MIIM in both MII mode and RMII mode.

The following table shows the MII Management frame format for the KSZ8041NL.

	Preamble	Start of Frame	Read/Write OP Code	PHY Address Bits [4:0]	REG Address Bits [4:0]	TA	Data Bits [15:0]	Idle
Read	32 1's	01	10	00AAA	RRRRR	Z0	DDDDDDDD_DDDDDDD	Z
Write	32 1's	01	01	00AAA	RRRRR	10	DDDDDDDD_DDDDDDD	Z

Table 1. MII Management Frame Format

Interrupt (INTRP)

INTRP (pin 21) is an optional interrupt signal that is used to inform the external controller that there has been a status update in the KSZ8041NL PHY register. Bits[15:8] of register 1Bh are the interrupt control bits, and are used to enable and disable the conditions for asserting the INTRP signal. Bits[7:0] of register 1Bh are the interrupt status bits, and are used to indicate which interrupt conditions have occurred. The interrupt status bits are cleared after reading register 1Bh. Bit 9 of register 1Fh sets the interrupt level to active high or active low.

MII Data Interface

The Media Independent Interface (MII) is specified in Clause 22 of the IEEE 802.3u Specification. It provides a common interface between physical layer and MAC layer devices, and has the following key characteristics:

- Supports 10Mbps and 100Mbps data rates.
- Uses a 25MHz reference clock, sourced by the PHY.
- Provides independent 4-bit wide (nibble) transmit and receive data paths.
- Contains two distinct groups of signals: one for transmission and the other for reception.

By default, the KSZ8041NL is configured in MII mode after it is power-up or reset with the following:

- A 25MHz crystal connected to XI, XO (pins 9, 8), or an external 25MHz clock source (oscillator) connected to XI.
- CONFIG[2:0] (pins 18, 29, 28) set to '000' (default setting).

MII Signal Definition

The following table describes the MII signals. Refer to Clause 22 of the IEEE 802.3u Specification for detailed information.

MII Signal Name	Direction (with respect to PHY, KSZ8041NL signal)	Direction (with respect to MAC)	Description
TXC	Output	Input	Transmit Clock (2.5MHz for 100Mbps)
TXEN	Input	Output	Transmit Enable
TXD[3:0]	Input	Output	Transmit Data [3:0]
RXC	Output	Input	Receive Clock
			(2.5MHz for 10Mbps; 25MHz for 100Mbps)
RXDV	Output	Input	Receive Data Valid
RXD[3:0]	Output	Input	Receive Data [3:0]
RXER	Output	Input, or (not required)	Receive Error
CRS	Output	Input	Carrier Sense
COL	Output	Input	Collision Detection

Table 2. MII Signal Definition

Transmit Clock (TXC)

TXC is sourced by the PHY. It is a continuous clock that provides the timing reference for TXEN and TXD[3:0].

TXC is 2.5MHz for 10Mbps operation and 25MHz for 100Mbps operation.

Transmit Enable (TXEN)

TXEN indicates the MAC is presenting nibbles on TXD[3:0] for transmission. It is asserted synchronously with the first nibble of the preamble and remains asserted while all nibbles to be transmitted are presented on the MII, and is negated prior to the first TXC following the final nibble of a frame.

TXEN transitions synchronously with respect to TXC.

Transmit Data [3:0] (TXD[3:0])

TXD[3:0] transitions synchronously with respect to TXC. When TXEN is asserted, TXD[3:0] are accepted for transmission by the PHY. TXD[3:0] is "00" to indicate idle when TXEN is de-asserted. Values other than "00" on TXD[3:0] while TXEN is de-asserted are ignored by the PHY.

Receive Clock (RXC)

RXC provides the timing reference for RXDV, RXD[3:0], and RXER.

- In 10Mbps mode, RXC is recovered from the line while carrier is active. RXC is derived from the PHY's reference clock when the line is idle, or link is down.
- In 100Mbps mode, RXC is continuously recovered from the line. If link is down, RXC is derived from the PHY's reference clock.

RXC is 2.5MHz for 10Mbps operation and 25MHz for 100Mbps operation.

Receive Data Valid (RXDV)

RXDV is driven by the PHY to indicate that the PHY is presenting recovered and decoded nibbles on RXD[3:0].

• In 10Mbps mode, RXDV is asserted with the first nibble of the SFD (Start of Frame Delimiter), "5D", and remains asserted until the end of the frame.

In 100Mbps mode, RXDV is asserted from the first nibble of the preamble to the last nibble of the frame.

RXDV transitions synchronously with respect to RXC.

Receive Data [3:0] (RXD[3:0])

RXD[3:0] transitions synchronously with respect to RXC. For each clock period in which RXDV is asserted, RXD[3:0] transfers a nibble of recovered data from the PHY.

Receive Error (RXER)

RXER is asserted for one or more RXC periods to indicate that a Symbol Error (e.g. a coding error that a PHY is capable of detecting, and that may otherwise be undetectable by the MAC sub-layer) was detected somewhere in the frame presently being transferred from the PHY.

RXER transitions synchronously with respect to RXC. While RXDV is de-asserted, RXER has no effect on the MAC.

Carrier Sense (CRS)

CRS is asserted and de-asserted as follows:

- In 10Mbps mode, CRS assertion is based on the reception of valid preambles. CRS de-assertion is based on the reception of an end-of-frame (EOF) marker.
- In 100Mbps mode, CRS is asserted when a start-of-stream delimiter, or /J/K symbol pair is detected. CRS is deasserted when an end-of-stream delimiter, or /T/R symbol pair is detected. Additionally, the PMA layer de-asserts CRS if IDLE symbols are received without /T/R.

Collision (COL)

COL is asserted in half-duplex mode whenever the transmitter and receiver are simultaneously active on the line. This is used to inform the MAC that a collision has occurred during its transmission to the PHY.

COL transitions asynchronously with respect to TXC and RXC.

Reduced MII (RMII) Data Interface

The Reduced Media Independent Interface (RMII) specifies a low pin count Media Independent Interface (MII). It provides a common interface between physical layer and MAC layer devices, and has the following key characteristics:

- Supports 10Mbps and 100Mbps data rates.
- Uses a single 50MHz reference clock provided by the MAC or the system board.
- Provides independent 2-bit wide (di-bit) transmit and receive data paths.
- Contains two distinct groups of signals: one for transmission and the other for reception.

The KSZ8041NL is configured in RMII mode after it is power-up or reset with the following:

- A 50MHz reference clock connected to REFCLK (pin 9).
- CONFIG[2:0] (pins 18, 29, 28) set to '001'.

In RMII mode, unused MII signals, TXD[3:2] (pins 27, 26), are tied to ground.

RMII Signal Definition

The following table describes the RMII signals. Refer to RMII Specification for detailed information.

RMII Signal Name	Direction (with respect to PHY, KSZ8041NL signal)	Direction (with respect to MAC)	Description
REF_CLK	Input	Input, or Output	Synchronous 50 MHz clock reference for receive, transmit and control interface
TX_EN	Input	Output	Transmit Enable
TXD[1:0]	Input	Output	Transmit Data [1:0]
CRS_DV	Output	Input	Carrier Sense/Receive Data Valid
RXD[1:0]	Output	Input	Receive Data [1:0]
RX_ER	Output	Input, or (not required)	Receive Error

Table 3. RMII Signal Description

Reference Clock (REF_CLK)

REF_CLK is sourced by the MAC or system board. It is a continuous 50MHz clock that provides the timing reference for TX_EN, TXD[1:0], CRS_DV, RXD[1:0], and RX_ER.

Transmit Enable (TX_EN)

TX_EN indicates that the MAC is presenting di-bits on TXD[1:0] for transmission. It is asserted synchronously with the first nibble of the preamble and remains asserted while all di-bits to be transmitted are presented on the RMII, and is negated prior to the first REF_CLK following the final di-bit of a frame.

TX EN transitions synchronously with respect to REF CLK.

Transmit Data [1:0] (TXD[1:0])

TXD[1:0] transitions synchronously with respect to REF_CLK. When TX_EN is asserted, TXD[1:0] are accepted for transmission by the PHY. TXD[1:0] is "00" to indicate idle when TX_EN is de-asserted. Values other than "00" on TXD[1:0] while TX_EN is de-asserted are ignored by the PHY.

Carrier Sense/Receive Data Valid (CRS DV)

CRS_DV is asserted by the PHY when the receive medium is non-idle. It is asserted asynchronously on detection of carrier. This is when squelch is passed in 10Mbps mode, and when 2 non-contiguous zeroes in 10 bits are detected in 100Mbps mode. Loss of carrier results in the de-assertion of CRS_DV.

So long as carrier detection criteria are met, CRS_DV remains asserted continuously from the first recovered di-bit of the frame through the final recovered di-bit, and it is negated prior to the first REF_CLK that follows the final di-bit. The data on RXD[1:0] is considered valid once CRS_DV is asserted. However, since the assertion of CRS_DV is asynchronous relative to REF_CLK, the data on RXD[1:0] is "00" until proper receive signal decoding takes place.

Receive Data [1:0] (RXD[1:0])

RXD[1:0] transitions synchronously to REF_CLK. For each clock period in which CRS_DV is asserted, RXD[1:0] transfers two bits of recovered data from the PHY. RXD[1:0] is "00" to indicate idle when CRS_DV is de-asserted. Values other than "00" on RXD[1:0] while CRS_DV is de-asserted are ignored by the MAC.

Receive Error (RX_ER)

RX_ER is asserted for one or more REF_CLK periods to indicate that a Symbol Error (e.g. a coding error that a PHY is capable of detecting, and that may otherwise be undetectable by the MAC sub-layer) was detected somewhere in the frame presently being transferred from the PHY.

RX_ER transitions synchronously with respect to REF_CLK. While CRS_DV is de-asserted, RX_ER has no effect on the MAC.

Collision Detection

The MAC regenerates the COL signal of the MII from TX_EN and CRS_DV.

HP Auto MDI/MDI-X

HP Auto MDI/MDI-X configuration eliminates the confusion of whether to use a straight cable or a crossover cable between the KSZ8041NL and its link partner. This feature allows the KSZ8041NL to use either type of cable to connect with a link partner that is in either MDI or MDI-X mode. The auto-sense function detects transmit and receive pairs from the link partner, and then assigns transmit and receive pairs of the KSZ8041NL accordingly.

HP Auto MDI/MDI-X is enabled by default. It is disabled by writing a one to register 1F bit 13. MDI and MDI-X mode is selected by register 1F bit 14 if HP Auto MDI/MDI-X is disabled.

An isolation transformer with symmetrical transmit and receive data paths is recommended to support auto MDI/MDI-X.

The IEEE 802.3u Standard defines MDI and MDI-X as follow:

MDI		MDI-X	
RJ-45 Pin	Signal	RJ-45 Pin	Signal
1	TD+	1	RD+
2	TD-	2	RD-
3	RD+	3	TD+
6	RD-	6	TD-

Table 4. MDI/MDI-X Pin Definition

Straight Cable

A straight cable connects a MDI device to a MDI-X device, or a MDI-X device to a MDI device. The following diagram depicts a typical straight cable connection between a NIC card (MDI) and a switch, or hub (MDI-X).

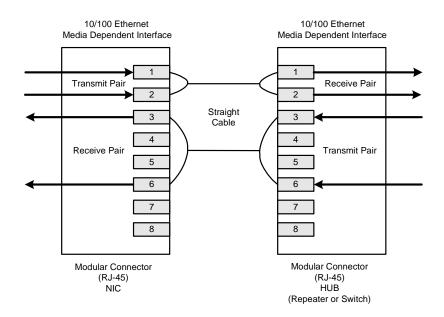


Figure 2. Typical Straight Cable Connection

Crossover Cable

A crossover cable connects a MDI device to another MDI device, or a MDI-X device to another MDI-X device. The following diagram depicts a typical crossover cable connection between two switches or hubs (two MDI-X devices).

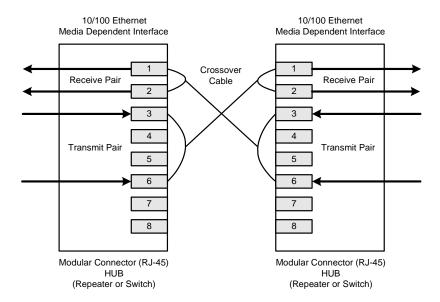


Figure 3. Typical Crossover Cable Connection

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Power Management

The KSZ8041NL offers the following power management modes:

Power Saving Mode

This mode is used to reduce power consumption when the cable is unplugged. It is in effect when auto-negotiation mode is enabled, cable is disconnected, and register 1F bit 10 is set to 1. Under power saving mode, the KSZ8041NL shuts down all transceiver blocks, except for transmitter, energy detect and PLL circuits. Additionally, in MII mode, the RXC clock output is disabled. RXC clock is enabled after the cable is connected and link is established.

Power saving mode is disabled by writing a zero to register 1F bit 10.

Power Down Mode

This mode is used to power down the entire KSZ8041NL device when it is not in use. Power down mode is enabled by writing a one to register 0 bit 11. In the power down state, the KSZ8041NL disables all internal functions, except for the MII management interface.

Reference Clock Connection Options

A crystal or clock source, such as an oscillator, is used to provide the reference clock for the KSZ8041NL. The reference clock is 25MHz for MII mode and 50MHz for RMII mode. The following two figures illustrate how to connect the reference clock to XI / REFCLK (pin 9) and XO (pin 8) of the KSZ8041NL.

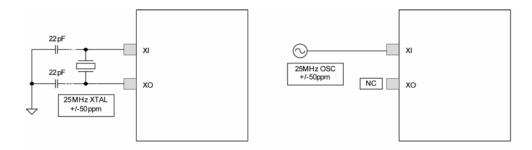


Figure 4. 25MHz Crystal / Oscillator Reference Clock for MII Mode

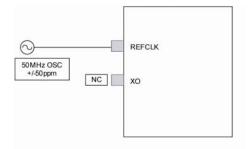


Figure 5. 50MHz Oscillator Reference Clock for RMII Mode

Reference Circuit for Power and Ground Connections

The KSZ8041NL is a single 3.3V supply device with a built-in 1.8V low noise regulator. The power and ground connections are shown in the following figure and table.

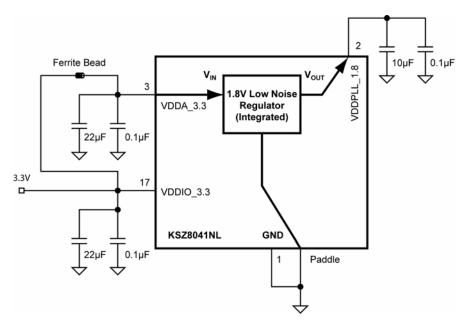


Figure 6. KSZ8041NL Power and Ground Connections

Power Pin	Pin Number	Description
VDDPLL_1.8	2	Decouple with 10uF and 0.1uF capacitors-to-ground.
VDDA_3.3	3	Connect to board's 3.3V supply through ferrite bead.
VDDIO_3.3	17	Connect to board's 3.3V supply.

Table 5. KSZ8041NL Power Pin Description

Register Map

Register Number (Hex)	Description
0h	Basic Control
1h	Basic Status
2h	PHY Identifier 1
3h	PHY Identifier 2
4h	Auto-Negotiation Advertisement
5h	Auto-Negotiation Link Partner Ability
6h	Auto-Negotiation Expansion
7h	Auto-Negotiation Next Page
8h	Link Partner Next Page Ability
9h – 14h	Reserved
15h	RXER Counter
16h – 1Ah	Reserved
1Bh	Interrupt Control/Status
1Ch – 1Dh	Reserved
1Eh	PHY Control 1
1Fh	PHY Control 2

Register Description

Address	Name	Description	Mode ⁽¹⁾	Default
Register 0h	- Basic Control			
0.15	Reset	1 = Software reset 0 = Normal operation This bit is self-cleared after a '1' is written to it.	RW/SC	0
0.14	Loop-back	1 = Loop-back mode 0 = Normal operation	RW	0
0.13	Speed Select (LSB)	1 = 100Mbps 0 = 10Mbps This bit is ignored if auto-negotiation is enabled (register 0.12 = 1).	RW	Set by SPEED strapping pin. See "Strapping Options" section for details.
0.12	Auto- Negotiation Enable	1 = Enable auto-negotiation process 0 = Disable auto-negotiation process If enabled, auto-negotiation result overrides settings in register 0.13 and 0.8.	RW	Set by NWAYEN strapping pin. See "Strapping Options" section for details.
0.11	Power Down	1 = Power down mode 0 = Normal operation	RW	0
0.10	Isolate	1 = Electrical isolation of PHY from MII and TX+/TX- 0 = Normal operation	RW	Set by ISO strapping pin. See "Strapping Options" section for details.
0.9	Restart Auto- Negotiation	1 = Restart auto-negotiation process0 = Normal operation.This bit is self-cleared after a '1' is written to it.	RW/SC	0

Address	Name	Description	Mode ⁽¹⁾	Default
0.8	Duplex Mode	1 = Full-duplex	RW	Set by DUPLEX strapping pin.
		0 = Half-duplex		See "Strapping Options" section for details.
0.7	Collision Test	1 = Enable COL test	RW	0
		0 = Disable COL test		
0.6:1	Reserved		RO	000_000
0.0	Disable	0 = Enable transmitter	RW	0
	Transmitter	1 = Disable transmitter		
Register 1h	n – Basic Status			•
 1.15	100Base-T4	1 = T4 capable	RO	0
		0 = Not T4 capable		
1.14	100Base-TX	1 = Capable of 100Mbps full-duplex	RO	1
	Full Duplex	0 = Not capable of 100Mbps full-duplex		
1.13	100Base-TX	1 = Capable of 100Mbps half-duplex	RO	1
	Half Duplex	0 = Not capable of 100Mbps half-duplex		
1.12	10Base-T Full	1 = Capable of 10Mbps full-duplex	RO	1
	Duplex	0 = Not capable of 10Mbps full-duplex		
1.11	10Base-T Half	1 = Capable of 10Mbps half-duplex	RO	1
	Duplex	0 = Not capable of 10Mbps half-duplex		
1.10:7	Reserved		RO	0000
1.6	No Preamble	1 = Preamble suppression	RO	1
		0 = Normal preamble		
1.5	Auto-	1 = Auto-negotiation process completed	RO	0
	Negotiation Complete	0 = Auto-negotiation process not completed		
1.4	Remote Fault	1 = Remote fault	RO/LH	0
		0 = No remote fault		
1.3	Auto-	1 = Capable to perform auto-negotiation	RO	1
	Negotiation Ability	0 = Not capable to perform auto-negotiation		
1.2	Link Status	1 = Link is up	RO/LL	0
		0 = Link is down		
1.1	Jabber Detect	1 = Jabber detected	RO/LH	0
		0 = Jabber not detected (default is low)		
1.0	Extended Capability	1 = Supports extended capabilities registers	RO	1
Register 2h	n – PHY Identifier 1		ı	•
2.15:0	PHY ID Number	Assigned to the 3rd through 18th bits of the Organizationally Unique Identifier (OUI). Kendin Communication's OUI is 0010A1 (hex)	RO	0022h

Address	Name	Description	Mode ⁽¹⁾	Default
Register 3h	– PHY Identifier 2			
3.15:10	PHY ID Number	Assigned to the 19th through 24th bits of the Organizationally Unique Identifier (OUI). Kendin Communication's OUI is 0010A1 (hex)	RO	0001_01
3.9:4	Model Number	Six bit manufacturer's model number	RO	01_0001
3.3:0	Revision Number	Four bit manufacturer's model number	RO	0010
Register 4h	– Auto-Negotiatio	n Advertisement		
4.15	Next Page	1 = Next page capable	RW	0
		0 = No next page capability.		
4.14	Reserved		RO	0
4.13	Remote Fault	1 = Remote fault supported	RW	0
		0 = No remote fault		
4.12:11	Reserved		RO	00
4.10	Pause	1 = PAUSE function supported	RW	0
		0 = No PAUSE function supported		
4.9	100Base-T4	1 = T4 capable	RO	0
		0 = No T4 capability		
4.8	100Base-TX	1 = 100Mbps full-duplex capable	RW	Set by SPEED strapping pin.
	Full-Duplex	0 = No 100Mbps full-duplex capability		See "Strapping Options" section for details.
4.7	100Base-TX	1 = 100Mbps half-duplex capable	RW	Set by SPEED strapping pin.
	Half-Duplex	0 = No 100Mbps half-duplex capability		See "Strapping Options" section for details.
4.6	10Base-T	1 = 10Mbps full-duplex capable	RW	1
	Full-Duplex	0 = No 10Mbps full-duplex capability		
4.5	10Base-T	1 = 10Mbps half-duplex capable	RW	1
	Half-Duplex	0 = No 10Mbps half-duplex capability		
4.4:0	Selector Field	[00001] = IEEE 802.3	RW	0_0001
Register 5h	– Auto-Negotiatio	n Link Partner Ability		
5.15	Next Page	1 = Next page capable	RO	0
		0 = No next page capability		
5.14	Acknowledge	1 = Link code word received from partner	RO	0
		0 = Link code word not yet received		
5.13	Remote Fault	1 = Remote fault detected	RO	0
		0 = No remote fault		
5.12	Reserved		RO	0
5.11:10	Pause	[00] = No PAUSE	RO	00
		[10] = Asymmetric PAUSE		
		[01] = Symmetric PAUSE		
		[11] = Asymmetric & Symmetric PAUSE		
5.9	100Base-T4	1 = T4 capable	RO	0
		0 = No T4 capability		

Address	Name	Description	Mode ⁽¹⁾	Default
5.8	100Base-TX	1 = 100Mbps full-duplex capable	RO	0
	Full-Duplex	0 = No 100Mbps full-duplex capability		
5.7	100Base-TX	1 = 100Mbps half-duplex capable	RO	0
	Half-Duplex	0 = No 100Mbps half-duplex capability		
5.6	10Base-T	1 = 10Mbps full-duplex capable	RO	0
	Full-Duplex	0 = No 10Mbps full-duplex capability		
5.5	10Base-T	1 = 10Mbps half-duplex capable	RO	0
	Half-Duplex	0 = No 10Mbps half-duplex capability		
5.4:0	Selector Field	[00001] = IEEE 802.3	RO	0_0001
Register 6h	- Auto-Negotiation	n Expansion		
6.15:5	Reserved		RO	0000_0000_000
6.4	Parallel	1 = Fault detected by parallel detection	RO/LH	0
	Detection Fault	0 = No fault detected by parallel detection.		
6.3	Link Partner	1 = Link partner has next page capability	RO	0
	Next Page Able	0 = Link partner does not have next page		
		capability		
6.2	Next Page Able	1 = Local device has next page capability	RO	1
	Able	0 = Local device does not have next page capability		
6.1	Page Received	1 = New page received	RO/LH	0
		0 = New page not received yet		
6.0	Link Partner	1 = Link partner has auto-negotiation capability	RO	0
	Auto- Negotiation Able	0 = Link partner does not have auto-negotiation capability		
Register 7h	- Auto-Negotiatio	n Next Page		
7.15	Next Page	1 = Additional next page(s) will follow	RW	0
		0 = Last page		
7.14	Reserved		RO	0
7.13	Message Page	1 = Message page	RW	1
		0 = Unformatted page		
7.12	Acknowledge2	1 = Will comply with message	RW	0
		0 = Cannot comply with message		
7.11	Toggle	1 = Previous value of the transmitted link code word equaled logic one	RO	0
		0 = Logic zero		
7.10:0	Message Field	11-bit wide field to encode 2048 messages	RW	000_0000_0001
Register 8h	– Link Partner Nex	ct Page Ability		
8.15	Next Page	1 = Additional Next Page(s) will follow	RO	0
		0 = Last page		
8.14	Acknowledge	1 = Successful receipt of link word	RO	0
		0 = No successful receipt of link word		
8.13	Message Page	1 = Message page	RO	0
		0 = Unformatted page		
	i	-		_ I

Address	Name	Description	Mode ⁽¹⁾	Default
8.12	Acknowledge2	1 = Able to act on the information	RO	0
		0 = Not able to act on the information		
8.11	Toggle	1 = Previous value of transmitted link code word equal to logic zero	RO	0
		0 = Previous value of transmitted link code word equal to logic one		
8.10:0	Message Field		RO	000_0000_0000
Register 15I	n – RXER Counter			
15.15:0	RXER Counter	Receive error counter for Symbol Error frames	RO/SC	0000h
Register 1B	h – Interrupt Contr	rol/Status		
1b.15	Jabber	1 = Enable Jabber Interrupt	RW	0
	Interrupt Enable	0 = Disable Jabber Interrupt		
1b.14	Receive Error	1 = Enable Receive Error Interrupt	RW	0
	Interrupt Enable	0 = Disable Receive Error Interrupt		
1b.13	Page Received	1 = Enable Page Received Interrupt	RW	0
	Interrupt Enable	0 = Disable Page Received Interrupt		
1b.12	Parallel Detect	1 = Enable Parallel Detect Fault Interrupt	RW	0
	Fault Interrupt Enable	0 = Disable Parallel Detect Fault Interrupt		
1b.11	Link Partner	1 = Enable Link Partner Acknowledge Interrupt	RW	0
	Acknowledge Interrupt Enable	0 = Disable Link Partner Acknowledge Interrupt		
1b.10	Link Down	1= Enable Link Down Interrupt	RW	0
	Interrupt Enable	0 = Disable Link Down Interrupt		
1b.9	Remote Fault	1 = Enable Remote Fault Interrupt	RW	0
	Interrupt Enable	0 = Disable Remote Fault Interrupt		
1b.8	Link Up	1 = Enable Link Up Interrupt	RW	0
	Interrupt Enable	0 = Disable Link Up Interrupt		
1b.7	Jabber	1 = Jabber occurred	RO/SC	0
	Interrupt	0 = Jabber did not occurred		
1b.6	Receive Error	1 = Receive Error occurred	RO/SC	0
	Interrupt	0 = Receive Error did not occurred		
1b.5	Page Receive Interrupt	1 = Page Receive occurred	RO/SC	0
41. 4	·	0 = Page Receive did not occurred	DC /2 -	1
1b.4	Parallel Detect Fault Interrupt	1 = Parallel Detect Fault did not accurred	RO/SC	0
1h 2	•	0 = Parallel Detect Fault did not occurred	PO/SC	0
1b.3	Link Partner Acknowledge Interrupt	1= Link Partner Acknowledge occurred 0= Link Partner Acknowledge did not occurred	RO/SC	U
1b.2	Link Down	1= Link Down occurred	RO/SC	0
	Interrupt	0= Link Down did not occurred		

Address	Name	Description	Mode ⁽¹⁾	Default
1b.1	Remote Fault	1= Remote Fault occurred	RO/SC	0
	Interrupt	0= Remote Fault did not occurred		
1b.0	Link Up	1= Link Up occurred	RO/SC	0
	Interrupt	0= Link Up did not occurred		
Register 1E	h – PHY Control 1			
1e:15:14	LED mode	[00] =	RW	00
		LED1: Speed		
		LED0: Link/Activity		
		[01] =		
		LED1: Activity		
		LED0: Link		
		[10] =		
		Reserved		
		[11] =		
		Reserved		
1e.13	Polarity	0 = Polarity is not reversed	RO	
		1 = Polarity is reversed		
1e.12	Reserved		RO	0
1e.11	MDI/MDI-X	0 = MDI	RO	
	State	1 = MDI-X		
1e:10:8	Reserved			
1e:7	Remote	0 = Normal mode	RW	0
	loopback	1 = Remote (analog) loop back is enable		
1e:6:0	Reserved			
Register 1F	h – PHY Control 2			
1f:15	HP_MDIX	0 = Micrel Auto MDI/MDI-X mode	RW	1
		1 = HP Auto MDI/MDI-X mode		
1f:14	MDI/MDI-X	When Auto MDI/MDI-X is disabled,	RW	0
	Select	0 = MDI Mode		
		Transmit on TX+/- (pins 7,6) and Receive on RX+/- (pins 5,4)		
		1 = MDI-X Mode		
		Transmit on RX+/- (pins 5,4) and Receive on TX+/- (pins 7,6)		
1f:13	Pairswap	1 = Disable auto MDI/MDI-X	RW	0
	Disable	0 = Enable auto MDI/MDI-X		
1f.12	Energy Detect	1 = Presence of signal on RX+/- analog wire pair	RO	0
		0 = No signal detected on RX+/-		

Address	Name	Description	Mode ⁽¹⁾	Default
1f.11	Force Link	1 = Force link pass	RW	0
		0 = Normal link operation		
		This bit bypasses the control logic and allow transmitter to send pattern even if there is no link.		
1f.10	Power Saving	1 = Enable power saving	RW	0
		0 = Disable power saving		
		If power saving mode is enabled and the cable is disconnected, the RXC clock output (in MII mode) is disabled. RXC clock is enabled after the cable is connected and link is established.		
1f.9	Interrupt Level	1 = Interrupt pin active high	RW	0
		0 = Interrupt pin active low		
1f.8	Enable Jabber	1 = Enable jabber counter	RW	1
		0 = Disable jabber counter		
1f.7	Auto-	1 = Auto-negotiation process completed	RW	0
	Negotiation Complete	0 = Auto-negotiation process not completed		
1f.6	Enable Pause	1 = Flow control capable	RO	0
	(Flow Control)	0 = No flow control capability		
1f.5	PHY Isolate	1 = PHY in isolate mode	RO	0
		0 = PHY in normal operation		
1f.4:2	Operation	[000] = still in auto-negotiation	RO	000
	Mode Indication	[001] = 10Base-T half-duplex		
	maioation	[010] = 100Base-TX half-duplex		
		[011] = reserved		
		[101] = 10Base-T full-duplex		
		[110] = 100Base-TX full-duplex		
		[111] = reserved		
1f.1	Enable SQE	1 = Enable SQE test	RW	0
	test	0 = Disable SQE test		
1f.0	Disable Data	1 = Disable scrambler	RW	0
	Scrambling	0 = Enable scrambler		

Note:

1. RW = Read/Write.

RO = Read only.

SC = Self-cleared.

LH = Latch high.

LL = Latch low.

Absolute Maximum Ratings(1)

Operating Ratings⁽²⁾

Supply Voltage	
(V _{DDPLL 1.8})	0.5V to +2.4V
(V _{DDIO_3.3} , V _{DDA_3.3})	0.5V to +4.0V
Input Voltage (all inputs)	0.5V to +4.0V
Output Voltage (all outputs)	0.5V to +4.0V
Lead Temperature (soldering, 10sec.)	260°C
Storage Temperature (T _s) ESD Rating ⁽³⁾	55°C to +150°C
ESD Rating ⁽³⁾	6kV

Supply Voltage	
(V _{DDIO_3.3} , V _{DDA_3.3})+3.	135V to +3.465V
Ambient Temperature (T _A)	
Maximum Junction Temperature (T _J Max)	125°C
Maximum Case Temperature (T _C Max)	150°C
Thermal Resistance (θ _{JA})	34°C/W
Thermal Resistance (θ _{JC})	6°C/W

Electrical Characteristics(4)

Symbol	Parameter	Condition	Min	Тур	Max	Units
Supply C	urrent ⁽⁵⁾		•			
I _{DD1}	100Base-TX	Chip only (no transformer);		53	58.3	mA
		Full-duplex traffic @ 100% utilization				
I _{DD2}	10Base-T	Chip only (no transformer);		38	41.8	mA
		Full-duplex traffic @ 100% utilization				
I _{DD3}	Power Saving Mode	Ethernet cable disconnected (reg. 1F.10 = 1)		32	35.2	mA
I _{DD4}	Power Down Mode	Software power down (reg. 0.11 = 1)		4	4.4	mA
TTL Input	s					
V _{IH}	Input High Voltage		2.0			V
V _{IL}	Input Low Voltage				0.8	V
I _{IN}	Input Current	V _{IN} = GND ~ VDDIO		-10	10	μ A
TTL Outp	uts					
V _{OH}	Output High Voltage	$I_{OH} = -4mA$	2.4			V
V _{OL}	Output Low Voltage	I _{OL} = 4mA			0.4	V
I _{oz}	Output Tri-State Leakage				10	μΑ
100Base-	TX Transmit (measured differentia	ally after 1:1 transformer)	•			
Vo	Peak Differential Output Voltage	100Ω termination across differential output	0.95		1.05	V
V _{IMB}	Output Voltage Imbalance	100Ω termination across differential output			2	%
t _r , t _f	Rise/Fall Time		3		5	ns
	Rise/Fall Time Imbalance		0		0.5	ns
	Duty Cycle Distortion				<u>+</u> 0.25	ns
	Overshoot				5	%
V _{SET}	Reference Voltage of ISET			0.65		V
	Output Jitter	Peak-to-peak		0.7	1.4	ns

Notes:

- 1. Exceeding the absolute maximum rating may damage the device. Stresses greater than the absolute maximum rating may cause permanent damage to the device. Operation of the device at these or any other conditions above those specified in the operating sections of this specification is not implied. Maximum conditions for extended periods may affect reliability.
- 2. The device is not guaranteed to function outside its operating rating.
- 3. Devices are ESD sensitive. Handling precautions recommended. Human body model, 1.5k in series with 100pF.
- 4. $T_A = 25$ °C. Specification for packaged product only.
- 5. Current consumption is for the single 3.3V supply KSZ8041NL device only, and includes the 1.8V supply voltage ($V_{DDPLL_1.8}$) that is provided by the KSZ8041NL. The PHY port's transformer consumes an additional 45mA @ 3.3V for 100Base-TX and 70mA @ 3.3V for 10Base-T.

Electrical Characteristics⁽⁶⁾

10Base-T	10Base-T Transmit (measured differentially after 1:1 transformer)						
V _P	Peak Differential Output Voltage	100 $Ω$ termination across differential output	2.2		2.8	V	
	Jitter Added	Peak-to-peak			3.5	ns	
t_r, t_f	Rise/Fall Time			25		ns	
10Base-T	10Base-T Receive						
V_{SQ}	Squelch Threshold	5MHz square wave		400		mV	

Notes:

^{6.} $T_A = 25$ °C. Specification for packaged product only.

Timing Diagrams

MII SQE Timing (10Base-T)

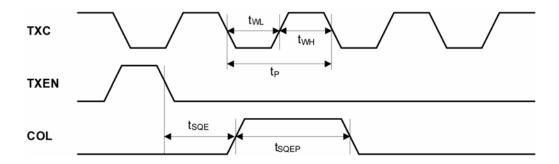


Figure 7. MII SQE Timing (10Base-T)

Timing Parameter	Description	Min	Тур	Max	Unit
t _P	TXC period		400		ns
t _{WL}	TXC pulse width low		200		ns
t _{WH}	TXC pulse width high		200		ns
t _{SQE}	COL (SQE) delay after TXEN de-asserted		2.5		us
t _{SQEP}	COL (SQE) pulse duration		1.0		us

Table 6. MII SQE Timing (10Base-T) Parameters

MII Transmit Timing (10Base-T)

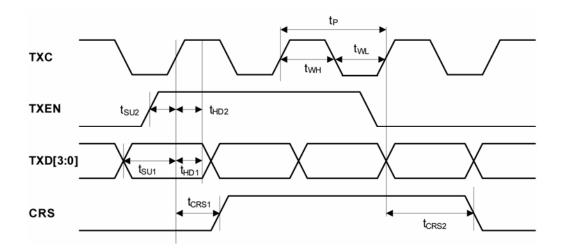


Figure 8. MII Transmit Timing (10Base-T)

Timing Parameter	Description	Min	Тур	Max	Unit
t _P	TXC period		400		ns
t _{WL}	TXC pulse width low		200		ns
t _{WH}	TXC pulse width high		200		ns
t _{SU1}	TXD[3:0] setup to rising edge of TXC	10			ns
t _{SU2}	TXEN setup to rising edge of TXC	10			ns
t _{HD1}	TXD[3:0] hold from rising edge of TXC	0			ns
t _{HD2}	TXEN hold from rising edge of TXC	0			ns
t _{CRS1}	TXEN high to CRS asserted latency		4		Bit Time
t _{CRS2}	TXEN low to CRS de-asserted latency		8		Bit Time

Table 7. MII Transmit Timing (10Base-T) Parameters

MII Receive Timing (10Base-T)

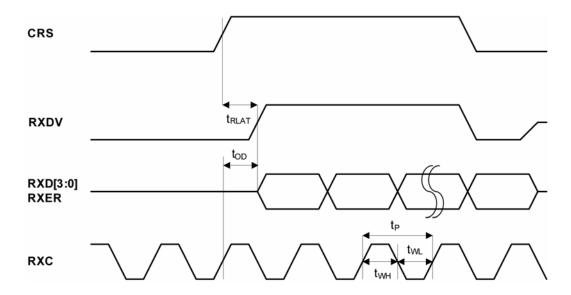


Figure 9. MII Receive Timing (10Base-T)

Timing Parameter	Description	Min	Тур	Max	Unit
t _P	RXC period		400		ns
t _{WL}	RXC pulse width low		200		ns
t _{WH}	RXC pulse width high		200		ns
t _{OD}	(RXD[3:0], RXER, RXDV) output delay from rising edge of RXC	182		225	ns
t _{RLAT}	CRS to (RXD[3:0], RXER, RXDV) latency		6.5		us

Table 8. MII Receive Timing (10Base-T) Parameters

MII Transmit Timing (100Base-TX)

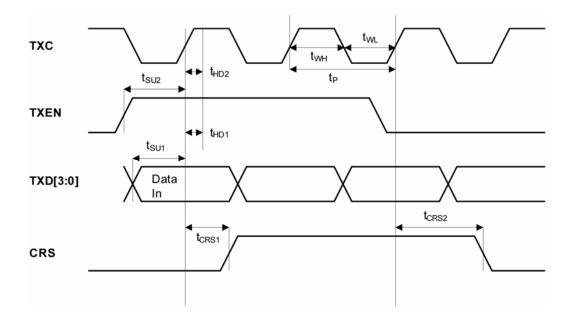


Figure 10. MII Transmit Timing (100Base-TX)

Timing Parameter	Description	Min	Тур	Max	Unit
t _P	TXC period		40		ns
t _{WL}	TXC pulse width low		20		ns
t _{WH}	TXC pulse width high		20		ns
t _{SU1}	TXD[3:0] setup to rising edge of TXC	10			ns
t _{SU2}	TXEN setup to rising edge of TXC	10			ns
t _{HD1}	TXD[3:0] hold from rising edge of TXC	0			ns
t _{HD2}	TXEN hold from rising edge of TXC	0			ns
t _{CRS1}	TXEN high to CRS asserted latency		4		Bit Time
t _{CRS2}	TXEN low to CRS de-asserted latency		4		Bit Time

Table 9. MII Transmit Timing (100Base-TX) Parameters

MII Receive Timing (100Base-TX)

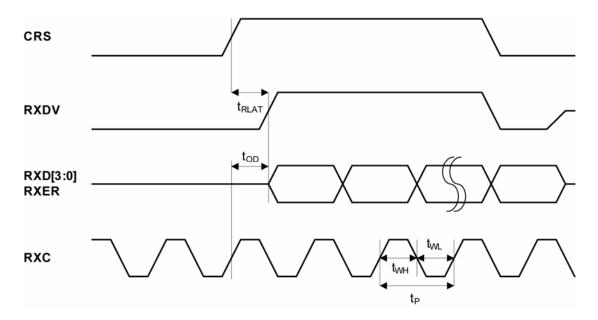


Figure 11. MII Receive Timing (100Base-TX)

Timing Parameter	Description	Min	Тур	Max	Unit
t _P	RXC period		40		ns
twL	RXC pulse width low		20		ns
t _{WH}	RXC pulse width high		20		ns
t _{OD}	(RXD[3:0], RXER, RXDV) output delay from rising edge of RXC	19		25	ns
t _{RLAT}	CRS to (RXD[3:0], RXER, RXDV) latency	1	2	3	Bit Time

Table 10. MII Receive Timing (100Base-TX) Parameters

RMII Timing

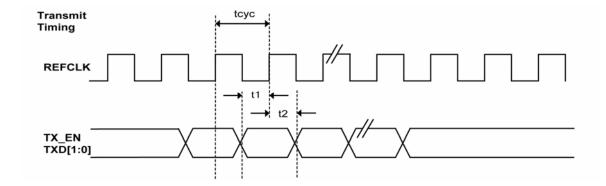


Figure 12. RMII Timing – Data Received from RMII

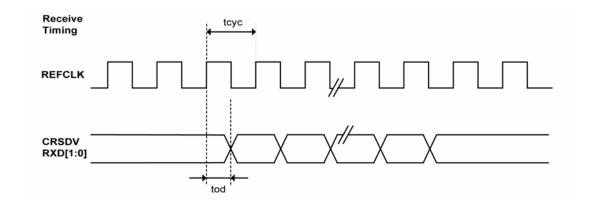


Figure 13. RMII Timing – Data Input to RMII

Timing Parameter	Description	Min	Тур	Max	Unit
t _{cyc}	Clock cycle		20		ns
t ₁	Setup time	4			ns
t ₂	Hold time	2			ns
t _{od}	Output delay	2.8		10	ns

Table 11. RMII Timing Parameters

Auto-Negotiation Timing

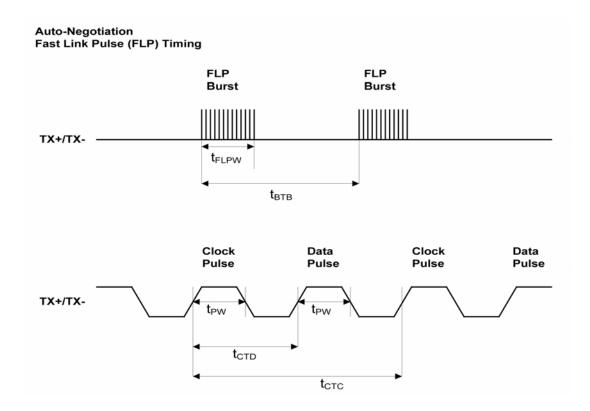


Figure 14. Auto-Negotiation Fast Link Pulse (FLP) Timing

Timing Parameter	Description	Min	Тур	Max	Units
t _{BTB}	FLP Burst to FLP Burst	8	16	24	ms
t _{FLPW}	FLP Burst width		2		ms
t _{PW}	Clock/Data Pulse width		100		ns
t _{CTD}	Clock Pulse to Data Pulse	55.5	64	69.5	μs
tctc	Clock Pulse to Clock Pulse	111	128	139	μs
	Number of Clock/Data Pulse per FLP Burst	17		33	

Table 12. Auto-Negotiation Fast Link Pulse (FLP) Timing Parameters

MDC/MDIO Timing

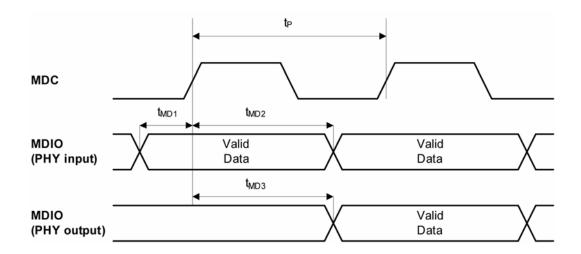


Figure 15. MDC/MDIO Timing

Timing Parameter	Description	Min	Тур	Max	Unit
t _P	MDC period		400		ns
t _{1MD1}	MDIO (PHY input) setup to rising edge of MDC	10			ns
t _{MD2}	MDIO (PHY input) hold from rising edge of MDC	10			ns
t _{MD3}	MDIO (PHY output) delay from rising edge of MDC		222		ns

Table 13. MDC/MDIO Timing Parameters

Reset Timing

The KSZ8041NL reset timing requirement is summarized in the following figure and table.

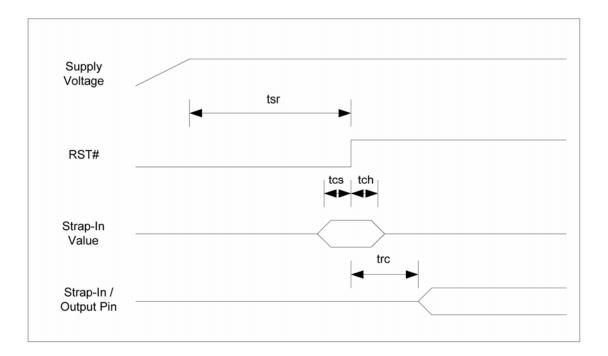


Figure 16. Reset Timing

Parameter	Description	Min	Max	Units
t _{sr}	Stable supply voltage to reset high	10		ms
t _{cs}	Configuration setup time	5		ns
t _{ch}	Configuration hold time	5		ns
t _{rc}	Reset to strap-in pin output	6		ns

Table 14. Reset Timing Parameters

After the de-assertion of reset, it is recommended to wait a minimum of 100 us before starting programming on the MIIM (MDC/MDIO) Interface.

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Reset Circuit

The following reset circuit is recommended for powering up the KSZ8041NL if reset is triggered by the power supply.

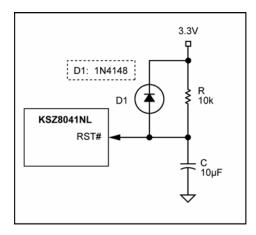


Figure 17. Recommended Reset Circuit

The following reset circuit is recommended for applications where reset is driven by another device (e.g., CPU or FPGA). At power-on-reset, R, C and D1 provide the necessary ramp rise time to reset the KSZ8041NL device. The RST_OUT_n from CPU/FPGA provides the warm reset after power up.

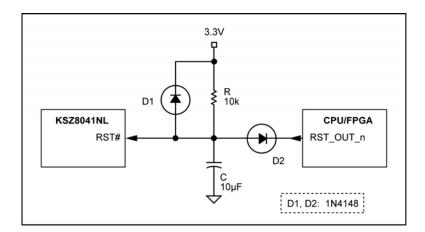


Figure 18. Recommended Reset Circuit for interfacing with CPU/FPGA Reset Output.

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Reference Circuits for LED Strapping Pins

The following figure shows the reference circuits for pull-up, float and pull-down on the LED1 and LED0 strapping pins.

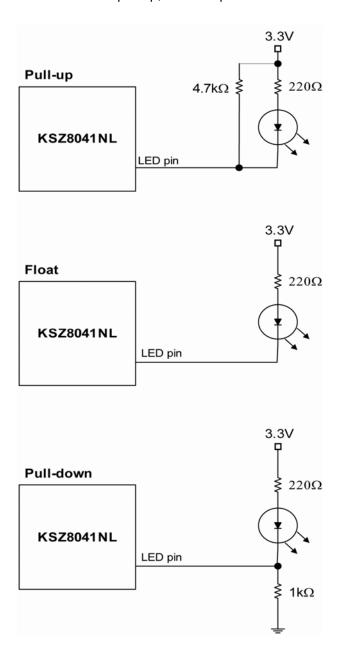


Figure 19. Reference Circuits for LED Strapping Pins

Selection of Isolation Transformer

A 1:1 isolation transformer is required at the line interface. An isolation transformer with integrated common-mode chokes is recommended for exceeding FCC requirements.

The following table gives recommended transformer characteristics.

Parameter	Value	Test Condition
Turns ratio	1 CT : 1 CT	
Open-circuit inductance (min.)	350μH	100mV, 100kHz, 8mA
Leakage inductance (max.)	0.4μΗ	1MHz (min.)
Inter-winding capacitance (max.)	12pF	
D.C. resistance (max.)	0.9Ω	
Insertion loss (max.)	1.0dB	0MHz – 65MHz
HIPOT (min.)	1500Vrms	

Table 15. Transformer Selection Criteria

Magnetic Manufacturer	Part Number	Auto MDI-X	Number of Port
Bel Fuse	S558-5999-U7	Yes	1
Bel Fuse (Mag Jack)	SI-46001	Yes	1
Bel Fuse (Mag Jack)	SI-50170	Yes	1
Delta	LF8505	Yes	1
LanKom	LF-H41S	Yes	1
Pulse	H1102	Yes	1
Pulse (low cost)	H1260	Yes	1
Transpower	HB726	Yes	1
TDK (Mag Jack)	TLA-6T718	Yes	1

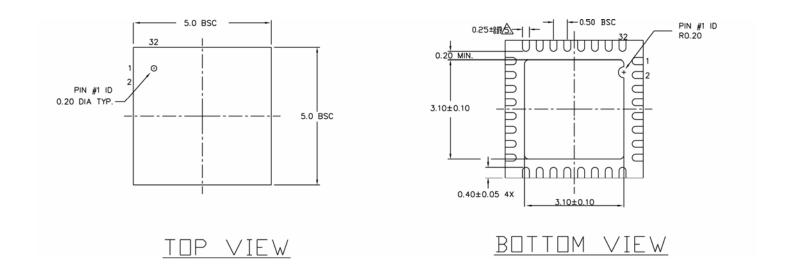
Table 16. Qualified Single Port Magnetics

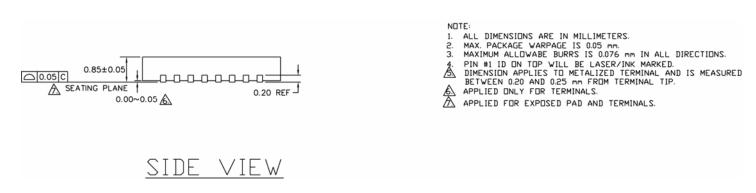
Selection of Reference Crystal

Characteristics	Value	Units
Frequency	25	MHz
Frequency tolerance (max)	±50	ppm
Load capacitance (max)	20	pF
Series resistance	40	Ω

Table 17. Typical Reference Crystal Characteristics

Package Information





32-Pin (5mm x 5mm) MLF® Package

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